

# RL78/F23, F24

R01AN6672EJ0200

Rev.2.00

## Hardware Design Guide

2023. 9.30

### Introduction

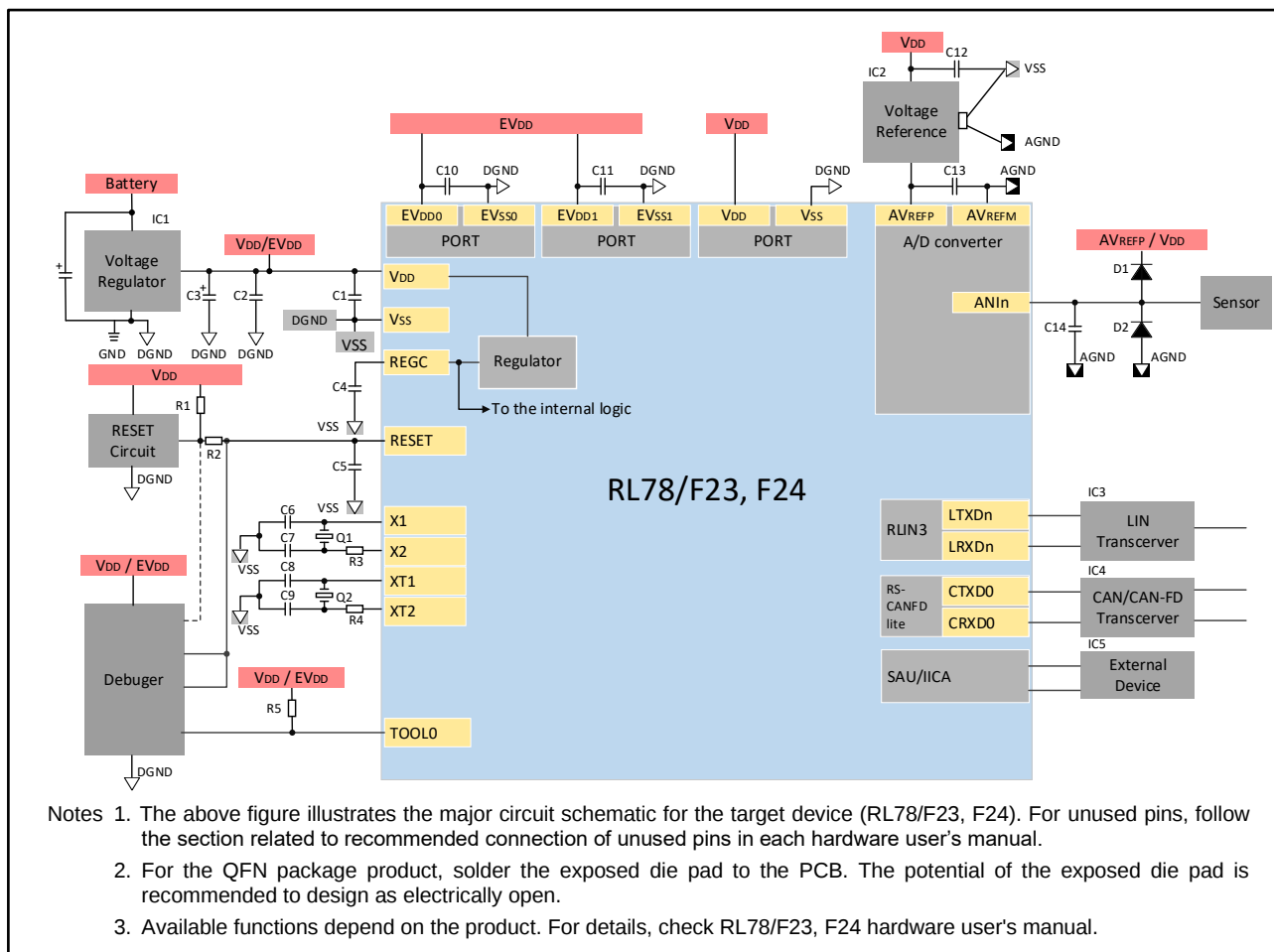
This document is intended to provide the hardware specific information and recommendations on RL78/F23, F24 usage. It should be used in conjunction with the corresponding Hardware User's Manual (includes the electrical characteristics).

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## 1. Typical Circuit Schematic

Figure 1 shows the typical circuit schematic for the RL78/F23, F24. And Table 1 shows minimum external components list on Figure 1.



**Figure 1: Typical Circuit Schematic for the RL78/F23, F24**

Table 1: Minimum External Components List

| Category                               | Components | Value (Typ.)                | Purpose                                                  | Remark                                                                                                                                                                                                                                   | Supplement     |
|----------------------------------------|------------|-----------------------------|----------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------|
| Power supply                           | IC1        | No recommended IC           | Generating power supply for V <sub>DD</sub>              | Depends on the user system.                                                                                                                                                                                                              | 1.1            |
|                                        | C1         | 0.1 $\mu$ F                 | Bypass capacitor                                         | Reference value. Connect as short and equidistant from the V <sub>DD</sub> and V <sub>SS</sub> pins as possible.                                                                                                                         |                |
|                                        | C2, C3     | No recommended value        | Stabilizing the output voltage of the voltage regulator  | Follow the recommendation of the data sheet of the voltage regulator IC.                                                                                                                                                                 |                |
|                                        | C4         | 0.47 $\mu$ F to 1.0 $\mu$ F | Stabilizing the internal regulator output voltage        | Connect the REGC and V <sub>SS</sub> pins as short as possible.                                                                                                                                                                          | 1.2            |
|                                        | C10        | 0.1 $\mu$ F                 | Bypass capacitor                                         | Reference value. Connect as short and equidistant from the EV <sub>DD0</sub> and EV <sub>SS0</sub> pins as possible.                                                                                                                     | –              |
|                                        | C11        | 0.1 $\mu$ F                 | Bypass capacitor                                         | Reference value. Connect as short and equidistant from the EV <sub>DD1</sub> and EV <sub>SS1</sub> pins as possible.                                                                                                                     |                |
| RESET                                  | R1         | 1.0 k $\Omega$              | Pull-up resistor                                         | Depends on the external reset circuit.                                                                                                                                                                                                   | 1.3            |
|                                        | C5         | 0.1 $\mu$ F                 | Capacitor                                                | Reference value. Connect the RESET and V <sub>SS</sub> pins as short as possible.                                                                                                                                                        |                |
| Oscillator circuit (Main system clock) | Q1         | 2.0 MHz to 20.0 MHz         | Generating clock signal source for the main system clock | Customers are requested to consult the resonator manufacturer to select an appropriate resonator and to determine the proper oscillation constant.<br>Connect the GND side of C6 and C7 to the V <sub>SS</sub> pin as short as possible. | 1.4.2<br>1.4.4 |
|                                        | C6, C7     | No recommended value        |                                                          |                                                                                                                                                                                                                                          |                |
|                                        | R3         | No recommended value        |                                                          |                                                                                                                                                                                                                                          |                |
| Oscillator circuit (Subsystem clock)   | Q2         | 32.768 kHz                  | Generating clock signal source for the subsystem clock   | Customers are requested to consult the resonator manufacturer to select an appropriate resonator and to determine the proper oscillation constant.<br>Connect the GND side of C8 and C9 to the V <sub>SS</sub> pin as short as possible. | 1.4.3<br>1.4.4 |
|                                        | C8, C9     | No recommended value        |                                                          |                                                                                                                                                                                                                                          |                |
|                                        | R4         | No recommended value        |                                                          |                                                                                                                                                                                                                                          |                |
| A/D converter                          | IC2        | No recommended IC           | Voltage reference                                        | Depends on the user system.                                                                                                                                                                                                              | 1.6            |
|                                        | C12        | No recommended value        | Bypass capacitor                                         | Depends on the external voltage reference IC.                                                                                                                                                                                            |                |
|                                        | C13        | 0.1 $\mu$ F                 | Bypass capacitor                                         | Connect the AV <sub>REFP</sub> and AV <sub>REFM</sub> pins as short as possible.                                                                                                                                                         |                |
|                                        | D1, D2     | V <sub>F</sub> $\leq$ 0.3 V | Noise protection                                         | Depends on the user system.                                                                                                                                                                                                              |                |
|                                        | C14        | 100 pF to 1000 $\mu$ F      | Stabilizing the sampling operation                       | Depends on the user system.<br>Connect the AN <sub>IN</sub> and V <sub>SS</sub> pins as short as possible.                                                                                                                               |                |
| Debug                                  | R2         | 10 k $\Omega$               | Current limit between Reset circuit and Debugger         | Depends on the external reset circuit.                                                                                                                                                                                                   | 1.7            |
|                                        | R5         | 10 k $\Omega$               | Pull-up resistor                                         | Be sure to pull-up this pin externally when on-chip debugging is enabled (pulling it down is prohibited).                                                                                                                                |                |
| LIN                                    | IC3        | No recommended IC           | LIN transceiver                                          | Depends on the user system.                                                                                                                                                                                                              | –              |
| CAN/CAN-FD                             | IC4        | No recommended IC           | CAN/CAN-FD transceiver                                   | Depends on the user system.                                                                                                                                                                                                              | –              |
| SAU/IICA                               | IC5        | No recommended IC           | Controlling external device                              | Depends on the user system.                                                                                                                                                                                                              | –              |

**Caution:** Pins and peripheral functions vary depending on the product. For details, refer to the User's Manual: Hardware of the product used.

## 1.1 Power Supply Circuit

### 1.1.1 Power Supply Pin

Connect the power supply pin to GND via a bypass capacitor. For the bypass capacitor, use a capacitor with good frequency characteristics such as a ceramic capacitor. Also, wire the power supply pin (+ side), bypass capacitor, and paired power supply pin (- side) as short and equidistant as possible. Bypass capacitors should always be connected to pairs of power supply pins. For example, the  $V_{DD}$  and  $V_{SS}$  pins, the  $EV_{DD0}/EV_{DD1}$  and  $EV_{SS0}/EV_{SS1}$  pins, and the  $AV_{REFP}$  and  $AV_{REFM}$  pins form a pair. Wire the pattern of the power supply pin with a pattern that is thicker than the other signal lines. Also, please design this product as  $V_{DD} = EV_{DD0}/EV_{DD1}$  and  $V_{SS} = EV_{SS0}/EV_{SS1}$  as shown in "Figure 1 Typical Circuit Schematic for the RL78/F23, F24".

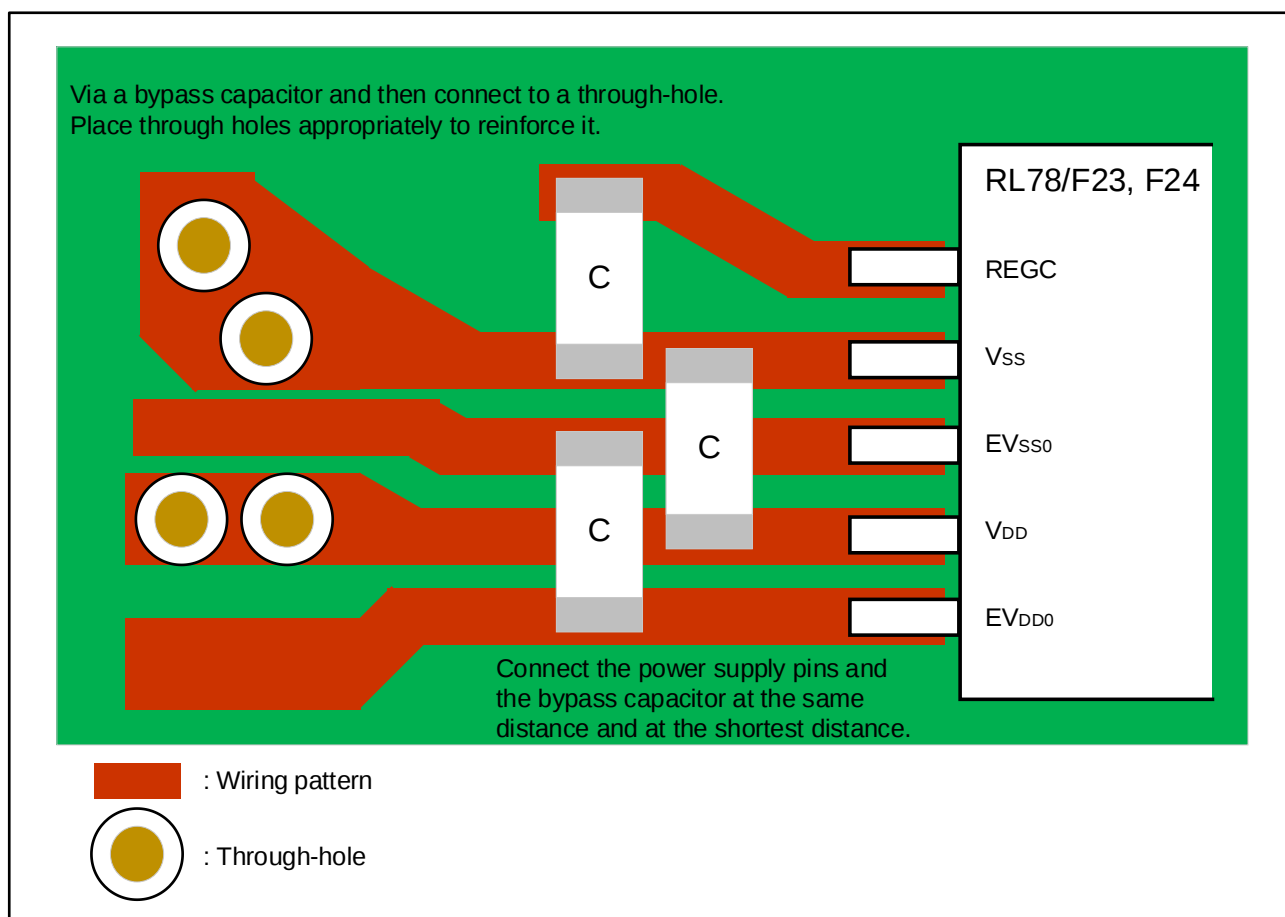
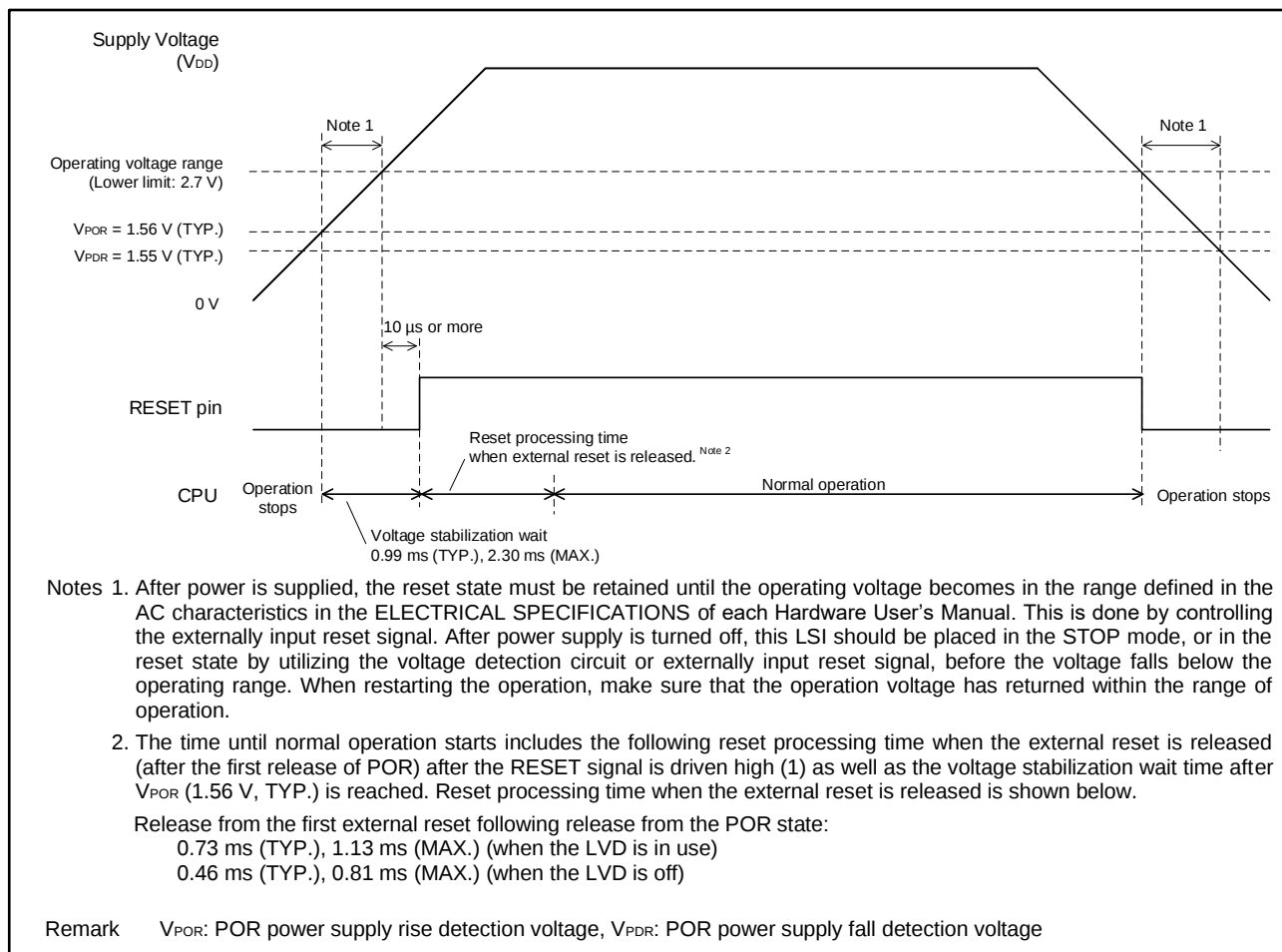


Figure 2: Connection Example of Power Supply Pin and Bypass Capacitor

### 1.1.2 Power Supply Timing

Please note that power supply timing according to the following use case.

- (1) When the externally input reset signal on the RESET pin is used.



**Figure 3: Power Supply Timing using the RESET pin**

## (2) When using LVD (interrupt &amp; reset mode)

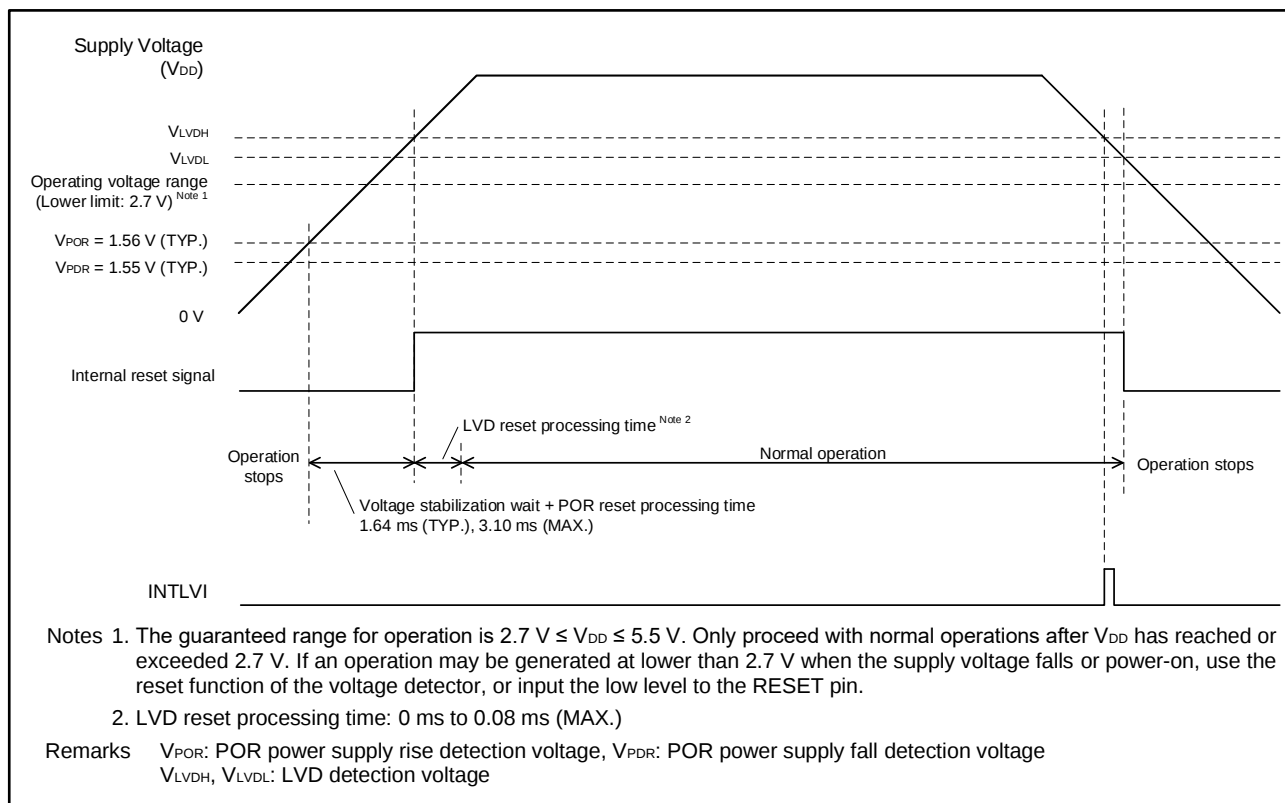


Figure 4: Power Supply Timing using LVD

## 1.2 REGC Pin

RL78/F23, F24 contain a circuit for operating the device with a constant voltage. At this time, in order to stabilize the regulator output voltage, connect the REGC pin to  $V_{SS}$  via a capacitor (0.47  $\mu\text{F}$  to 1  $\mu\text{F}$ ). Also, use a capacitor with good characteristics, since it is used to stabilize internal voltage.

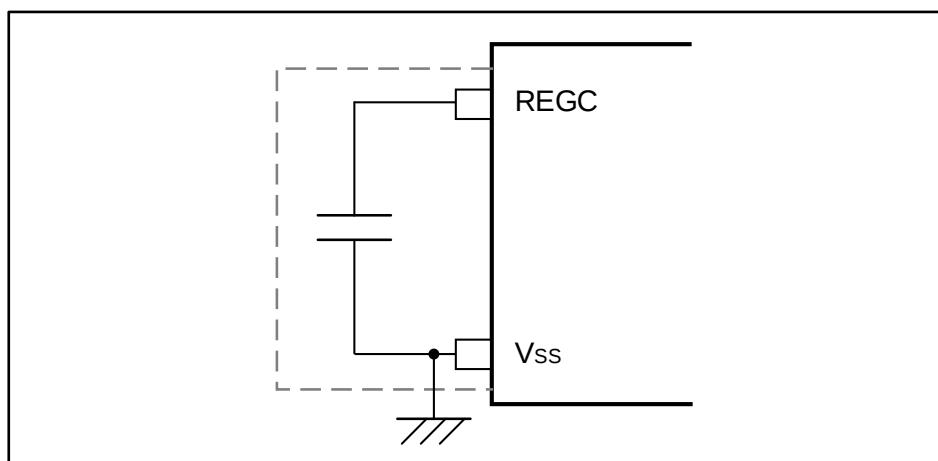


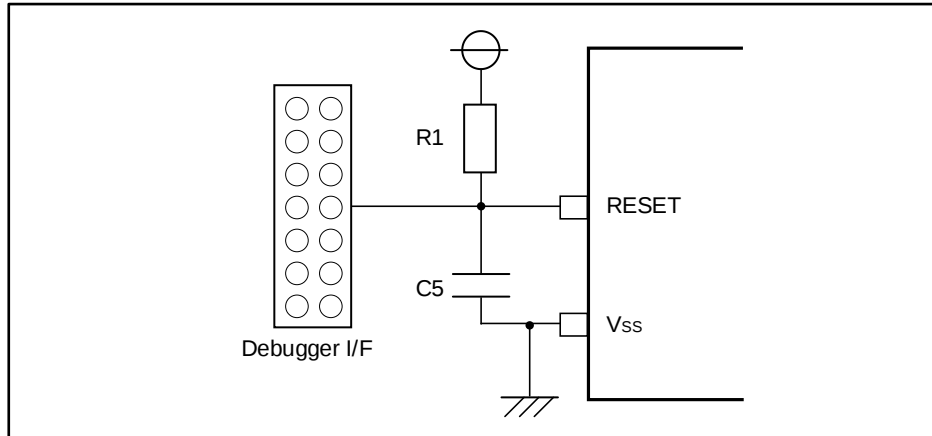
Figure 5: REGC Pin Connection

**Caution** Keep the wiring length as short as possible for the broken-line part in the above figure.

### 1.3 RESET Pin

RL78/F23, F24 has the on-chip Power-on reset circuit (POR). Therefore, a specific external RESET circuit is not required, and the minimum requirement of the RESET circuit is a pull-up resistor R1 (1 k $\Omega$  to 10 k $\Omega$ ) to V<sub>DD</sub>. When using the hot plug-in, place a ceramic capacitor C5 (about 0.1  $\mu$ F) close to the RESET pin to suppress noise to the RESET pin when the emulator is connected.

It depends on user system if an external RESET IC is necessary for a safety reason.



**Figure 6: Minimum RESET Pin Connection**

## 1.4 Oscillator Circuit

### 1.4.1 Oscillator Input/Output Pin

Wire the oscillator input/output pins (X1, X2, XT1, XT2) as short as possible, including the peripheral circuits. Also, guard the oscillator input/output pin pattern with a stable  $V_{SS}$  pattern so that it is not adjacent to other patterns (signal lines that carry high alternating current or signal lines that switch at high speed). See “1.4.4 Common Note for Oscillator Circuit” for details. Figure 7 shows an example of the oscillation circuit pattern. When using the subsystem clock, replace X1 and X2 with XT1 and XT2, respectively.

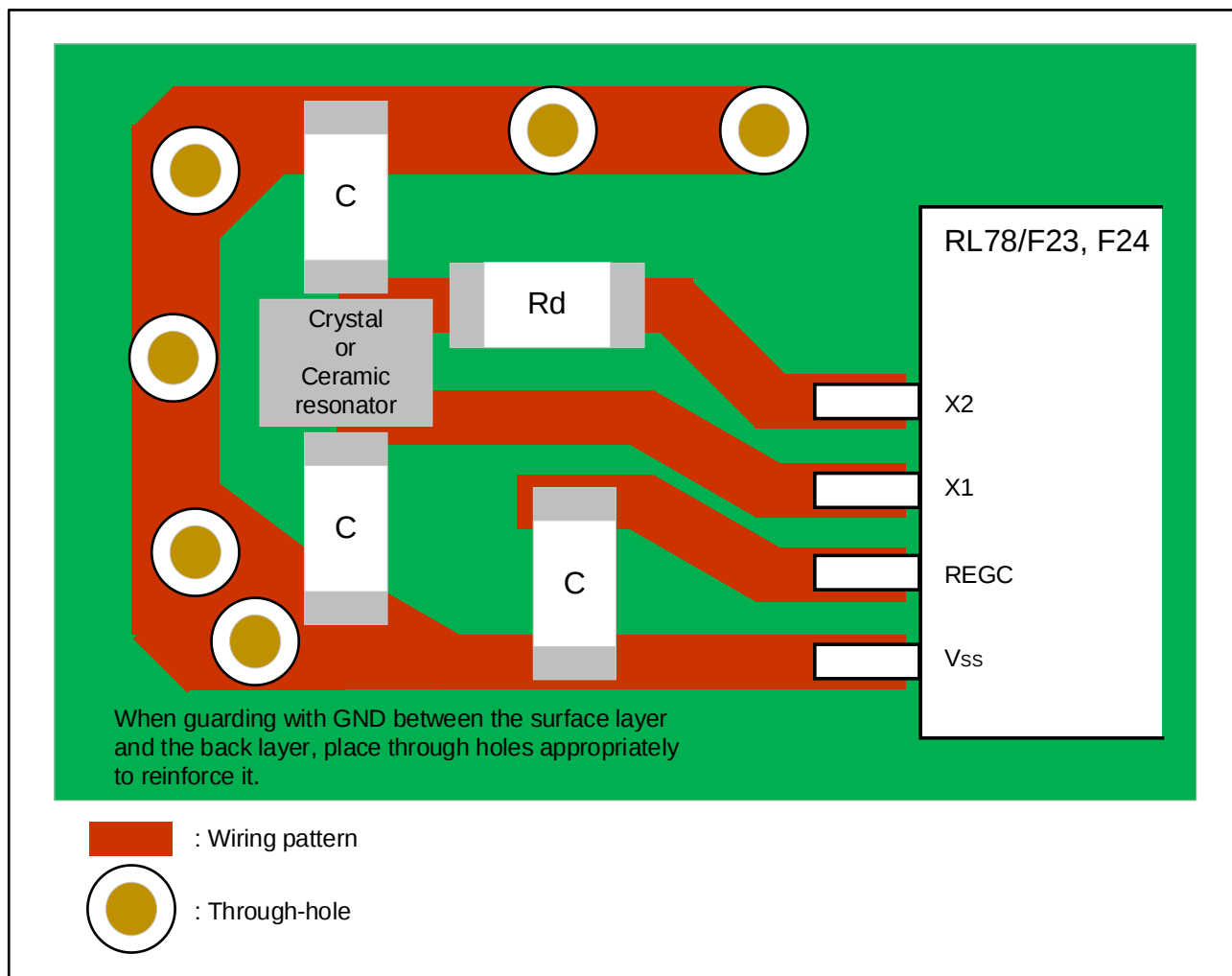


Figure 7: Connection Example of Oscillator Input/Output Circuit

### 1.4.2 Main System Clock

Typical circuit for the external oscillator circuit of the main system clock is illustrated below. The X1 oscillator oscillates with a crystal resonator or ceramic resonator (2 MHz to 20 MHz) connected to the X1 and X2 pins. Please check with the manufacturer of the resonator used for the resistance and capacitance values that make up the circuit.

An external clock can also be input. In this case, input the clock signal to the EXCLK pin.

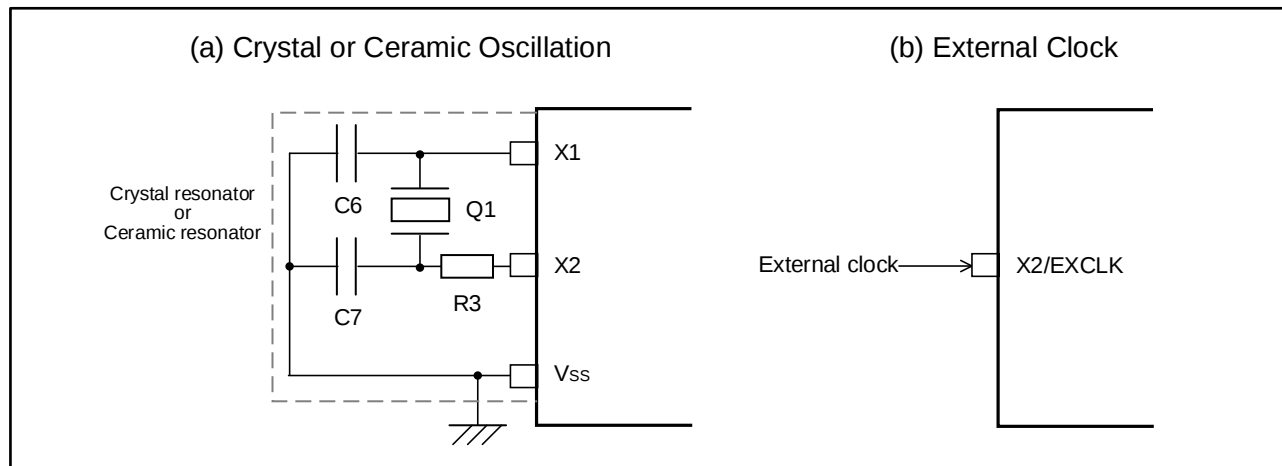


Figure 8: Main System Clock Connection

### 1.4.3 Subsystem Clock

Typical circuit for the external oscillator circuit of the subsystem clock is illustrated below. The XT1 oscillator oscillates with a crystal resonator (standard: 32.768 kHz) connected to the XT1 and XT2 pins.

Please check with the manufacturer of the resonator used for the resistance and capacitance values that make up the circuit.

An external clock can also be input. In this case, input the clock signal to the EXCLKS pin.

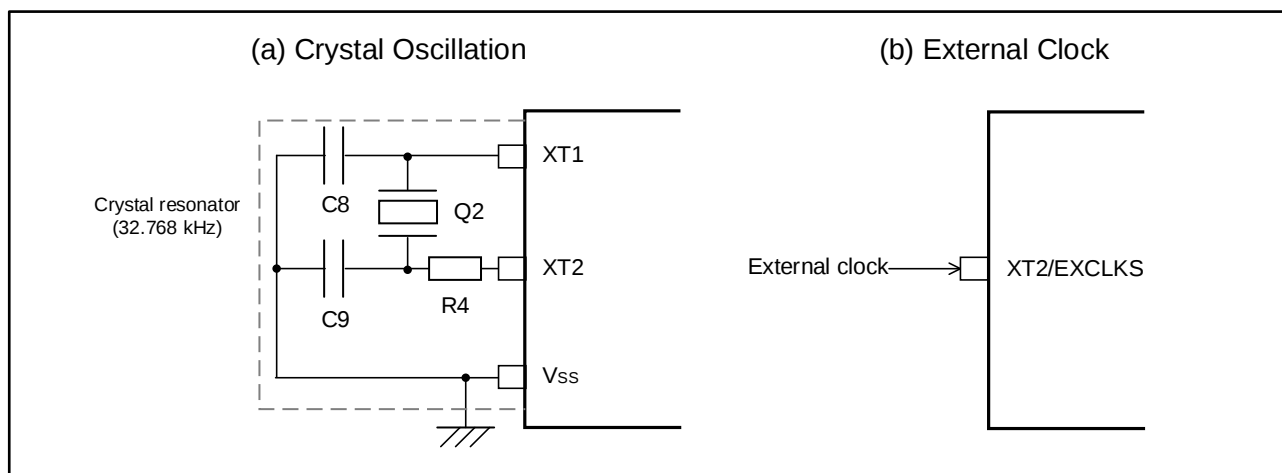


Figure 9: Subsystem Clock Connection

#### 1.4.4 Common Note for Oscillator Circuit

Customers are requested to consult the resonator manufacturer to select an appropriate resonator and to determine the proper oscillation constant.

When using the X1 oscillator and XT1 oscillator, wire as follows in the area enclosed by the broken lines in Figure 8 and Figure 9 to avoid an adverse effect from wiring capacitance.

- Keep the wiring length as short as possible.
- Do not cross the wiring with the other signal lines. Do not route the wiring near a signal line through which a high fluctuating current flow.
- Always make the ground point of the oscillator capacitor the same potential as  $V_{SS}$ . Do not ground the capacitor to a ground pattern through which a high current flow.
- Do not fetch signals from the oscillator.

The XT1 oscillator is a circuit with low amplification in order to achieve low-power consumption.

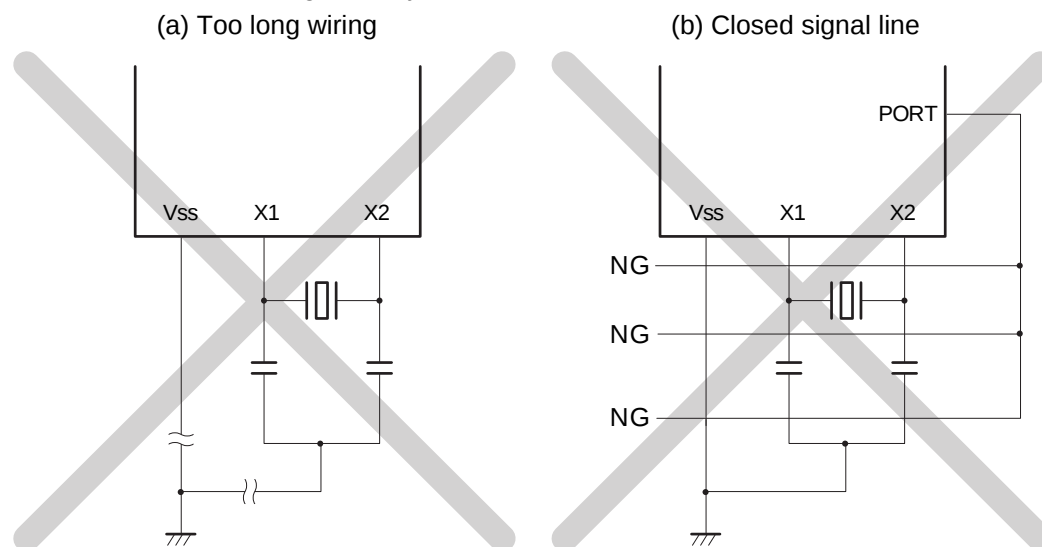
Note the following points when designing the circuit.

- Pins and circuit boards include parasitic capacitance. Therefore, perform oscillation evaluation using a circuit board to be actually used and confirm that there are no problems.
- Make the wiring between the XT1 and XT2 pins and the resonators as short as possible, and minimize the parasitic capacitance and wiring resistance. Note this particularly when the ultralow power consumption oscillation (AMPHS1, AMPHS0 = 1, 0) is selected.
- Configure the circuit of the circuit board, using material with little wiring resistance.
- Place a ground pattern that has the same potential as  $V_{SS}$  as much as possible near the XT1 oscillator.
- Be sure that the signal lines between the XT1 and XT2 pins, and the resonators do not cross with the other signal lines.

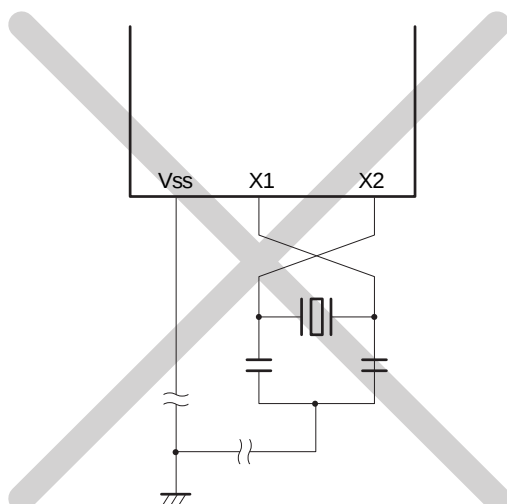
Do not route the wiring near a signal line through which a high fluctuating current flow.

- The impedance between the XT1 and XT2 pins may drop and oscillation may be disturbed due to moisture absorption of the circuit board in a high-humidity environment or dew condensation on the board. When using the circuit board in such an environment, take measures to damp-proof the circuit board, such as by coating.
- When coating the circuit board, use material that does not cause capacitance or leakage between the XT1 and XT2 pins.

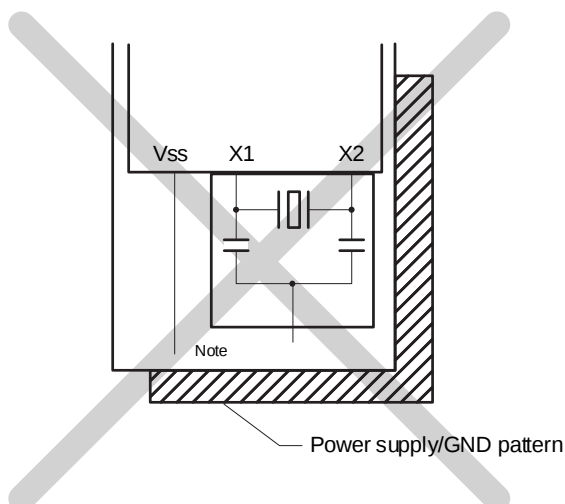
Please avoid the following PCB layout for the external OSC circuit.



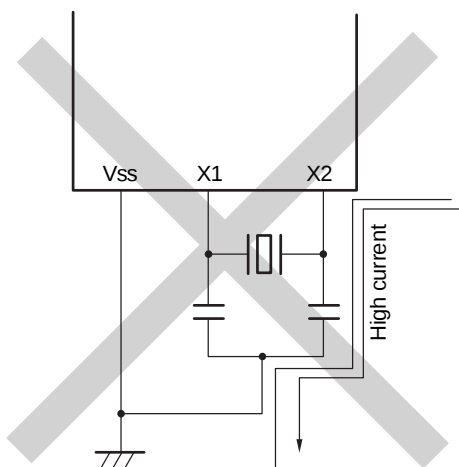
(c) The X1 and X2 signal line wires cross



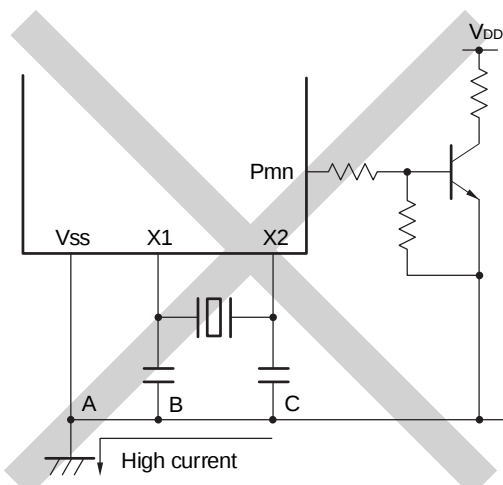
(d) A power supply / GND pattern exists under the X1 and X2 wires



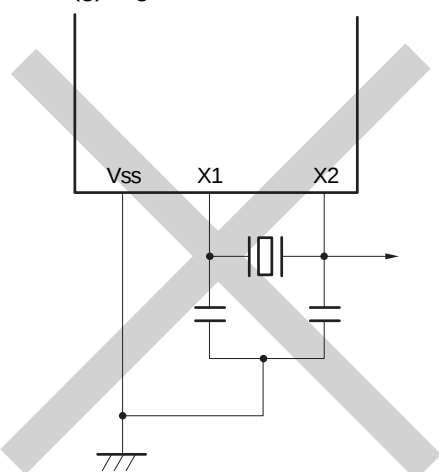
(e) Wiring near high alternating current



(f) Current flowing through ground of oscillator (potential at points A, B, and C fluctuates)



(g) Signals are fetched



**Caution** When X2 and XT1 are wired in parallel, the crosstalk noise of X2 may increase with XT1, resulting in malfunctioning.

**Remark** When using the subsystem clock, replace X1 and X2 with XT1 and XT2, respectively. Also, insert resistors in series on the XT2 side.

## 1.5 Note for I/O Port

### 1.5.1 Output Characteristics of I/O Port

The general purpose I/O of RL78/F23, F24 products have VDD-type I/O and EVDD-type I/O.

Note that port drive current capability is different according to I/O type.

**Table 2: IOH and IOL Characteristics for Grade-3 Products**

| Port Type | Applicable General Purpose I/O                                                                                                                           | Conditions                    | Port Characteristics (IOH and IOL) |
|-----------|----------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------|------------------------------------|
| VDD-type  | Per pin for P33, P34, P80 to P87, P90 to P97, P100 to P105                                                                                               | $2.7V \leq V_{DD} \leq 5.5V$  | IOH2: -0.1 mA<br>IOL2: 0.4 mA      |
|           | Total of all VDD-type pins                                                                                                                               | $2.7V \leq V_{DD} \leq 5.5V$  | IOH2: -2.0 mA<br>IOL2: 5.0 mA      |
| EVDD-type | Per pin for P00 to P03, P10 to P17, P30 to P32, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P106, P107, P120, P125 to P127, P130, P140, P150 to P157 | $4.0V \leq EV_{DD} \leq 5.5V$ | IOH1: -5.0 mA<br>IOL1: 8.5 mA      |
|           |                                                                                                                                                          | $2.7V \leq EV_{DD} < 4.0V$    | IOH1: -3.0 mA<br>IOL1: 4.0 mA      |
|           | Total of all EVDD-type pins                                                                                                                              | $4.0V \leq EV_{DD} \leq 5.5V$ | IOH1: -50.0 mA<br>IOL1: 65.0 mA    |
|           |                                                                                                                                                          | $2.7V \leq EV_{DD} < 4.0V$    | IOH1: -29.0 mA<br>IOL1: 50.0 mA    |

**Table 3: IOH and IOL Characteristics for Grade-4 Products**

| Port Type | Applicable General Purpose I/O                                                                                                                           | Conditions                    | Port Characteristics (IOH and IOL) |
|-----------|----------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------|------------------------------------|
| VDD-type  | Per pin for P33, P34, P80 to P87, P90 to P97, P100 to P105                                                                                               | $2.7V \leq V_{DD} \leq 5.5V$  | IOH2: -0.1 mA<br>IOL2: 0.4 mA      |
|           | Total of all VDD-type pins                                                                                                                               | $2.7V \leq V_{DD} \leq 5.5V$  | IOH2: -2.0 mA<br>IOL2: 5.0 mA      |
| EVDD-type | Per pin for P00 to P03, P10 to P17, P30 to P32, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P106, P107, P120, P125 to P127, P130, P140, P150 to P157 | $4.0V \leq EV_{DD} \leq 5.5V$ | IOH1: -5.0 mA<br>IOL1: 8.5 mA      |
|           |                                                                                                                                                          | $2.7V \leq EV_{DD} < 4.0V$    | IOH1: -3.0 mA<br>IOL1: 4.0 mA      |
|           | Total of all EVDD-type pins                                                                                                                              | $4.0V \leq EV_{DD} \leq 5.5V$ | IOH1: -42.0 mA<br>IOL1: 65.0 mA    |
|           |                                                                                                                                                          | $2.7V \leq EV_{DD} < 4.0V$    | IOH1: -29.0 mA<br>IOL1: 50.0 mA    |

**Table 4: IOH and IOL Characteristics for Grade-5 Products**

| Port Type | Applicable General Purpose I/O                                                                                                                           | Conditions                    | Port Characteristics (IOH and IOL) |
|-----------|----------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------|------------------------------------|
| VDD-type  | Per pin for P33, P34, P80 to P87, P90 to P97, P100 to P105                                                                                               | $2.7V \leq V_{DD} \leq 5.5V$  | IOH2: -0.1 mA<br>IOL2: 0.4 mA      |
|           | Total of all VDD-type pins                                                                                                                               | $2.7V \leq V_{DD} \leq 5.5V$  | IOH2: -2.0 mA<br>IOL2: 5.0 mA      |
| EVDD-type | Per pin for P00 to P03, P10 to P17, P30 to P32, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P106, P107, P120, P125 to P127, P130, P140, P150 to P157 | $4.0V \leq EV_{DD} \leq 5.5V$ | IOH1: -5.0 mA<br>IOL1: 8.5 mA      |
|           |                                                                                                                                                          | $2.7V \leq EV_{DD} < 4.0V$    | IOH1: -3.0 mA<br>IOL1: 4.0 mA      |
|           | Total of all EVDD-type pins                                                                                                                              | $4.0V \leq EV_{DD} \leq 5.5V$ | IOH1: -32.0 mA<br>IOL1: 55.0 mA    |
|           |                                                                                                                                                          | $2.7V \leq EV_{DD} < 4.0V$    | IOH1: -29.0 mA<br>IOL1: 45.0 mA    |

Remarks Some general purpose I/O may not be mounted depending on the product.  
P121 to P124 and P137 are input-only pins.

### 1.5.2 Recommended Connection of Unused Pins

Table 5 shows the recommended connections of unused pins for RL78/F23, F24 products.

**Table 5: Recommended Connection of Unused Pins**

| Port Type | Pin Name                                          | Recommended Connection of Unused Pin                                                                                                                                   |
|-----------|---------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| VDD-type  | P121 to P124, P137<br>(Input-only pin)            | Independently connect V <sub>DD</sub> or V <sub>SS</sub> via a resistor.                                                                                               |
|           | All VDD-type pins<br>except P121 to P124 and P137 | Input: Independently connect to V <sub>DD</sub> or V <sub>SS</sub> via a resistor.<br>[Reference resistance value: Pull-up with 20 kΩ resistor]<br>Output: Leave open. |
|           | RESET                                             | Connect to V <sub>DD</sub> directly or via a resistor.                                                                                                                 |
| EVDD-type | P40 <sup>Note</sup>                               | Input: Independently connect to EV <sub>DD</sub> via a resistor.<br>[Reference resistance value: 10 kΩ]<br>Output: Leave open.                                         |
|           | P130 (Output-only pin)                            | Leave open.                                                                                                                                                            |
|           | All EVDD-type pins<br>except P40 and P130         | Input: Independently connect to EV <sub>DD</sub> or EV <sub>SS</sub> via a resistor.<br>[Reference resistance value: 10 kΩ]<br>Output: Leave open.                     |

Note: TOOL0 (On-chip debugger/Flash memory programmer interface pin) function is assigned to P40. When using TOOL0 function on the board, select an input mode and connect to EV<sub>DD</sub> via a resistor (10 kΩ).

### 1.5.3 Peripheral I/O Redirection Function

Peripheral I/O pin of RL78/F23, F24 products can be assigned using the PIORx register and STPSTC register.

**Table 6: Peripheral I/O Redirection Function**

| Register | Bit Symbol       | Assignable Peripheral I/O Function                                         |
|----------|------------------|----------------------------------------------------------------------------|
| PIOR0    | PIOR00 to PIOR07 | TI00 to TI07 (Input pin of timer array unit)                               |
| PIOR1    | PIOR10 to PIOR17 | TO00 to TO07 (Output pin of timer array unit)                              |
| PIOR2    | PIOR20 to PIOR27 | TI10 to TI17 (Input pin of timer array unit)                               |
| PIOR3    | PIOR30 to PIOR37 | TO10 to TO17 (Output pin of timer array unit)                              |
| PIOR4    | PIOR40           | SI00/SDA00/RXD0, SO00/TXD0, SCL00/SCK00, SSI00 (Serial array unit I/O pin) |
|          | PIOR41           | SI01, SO01, SCK01, SSI01 (Serial array unit I/O pin)                       |
|          | PIOR42           | SI10/RXD1, SO10/TXD1, SCK10, SSI10 (Serial array unit I/O pin)             |
|          | PIOR43           | SI11, SO11, SCK11, SSI11 (Serial array unit I/O pin)                       |
|          | PIOR44           | LRXD0, LTXD0 (Serial data I/O pin of RLIN3 module)                         |
|          | PIOR45           | LRXD1, LTXD1 (Serial data I/O pin of RLIN3 module)                         |
|          | PIOR46           | CRXD0, CTXD0 (Serial data I/O pin of RS-CANFD lite module)                 |
| PIOR5    | PIOR50           | KR0 to KR7 (Key return input pin)                                          |
|          | PIOR52           | INTP2 (External interrupt input pin)                                       |
|          | PIOR53           | INTP3 (External interrupt input pin)                                       |
| PIOR6    | PIOR60 to PIOR67 | SNZOUT0 to SNZOUT7 (SNOOZE status output pin)                              |
| PIOR7    | PIOR70           | TRDIOA0/TRDCLK0 (Timer RDe I/O pin)                                        |
|          | PIOR71           | TRDIOB0 (Timer RDe I/O pin)                                                |
|          | PIOR73           | TRDIOD0 (Timer RDe I/O pin)                                                |
| PIOR8    | PIOR80           | RTC1HZ (Real-time clock correction clock signal output pin)                |
| PIOR9    | PIOR90           | TO01, TO02, TO03, TO07 (Output pin of timer array unit)                    |
|          | PIOR91           | SI10/RXD1, SCK10 (Serial array unit I/O pin)                               |
|          | PIOR92           | SO11 (Serial data output pin of serial array unit)                         |
|          | PIOR93           | LRXD1, LTXD1 (Serial data I/O pin of RLIN3 module)                         |
| STPSTC   | STPSEL           | STOPST (STOP status output pin)                                            |

### 1.5.4 Injected Current Input

This product supports injection current input.

Note that the characteristics differ depending on the pin.

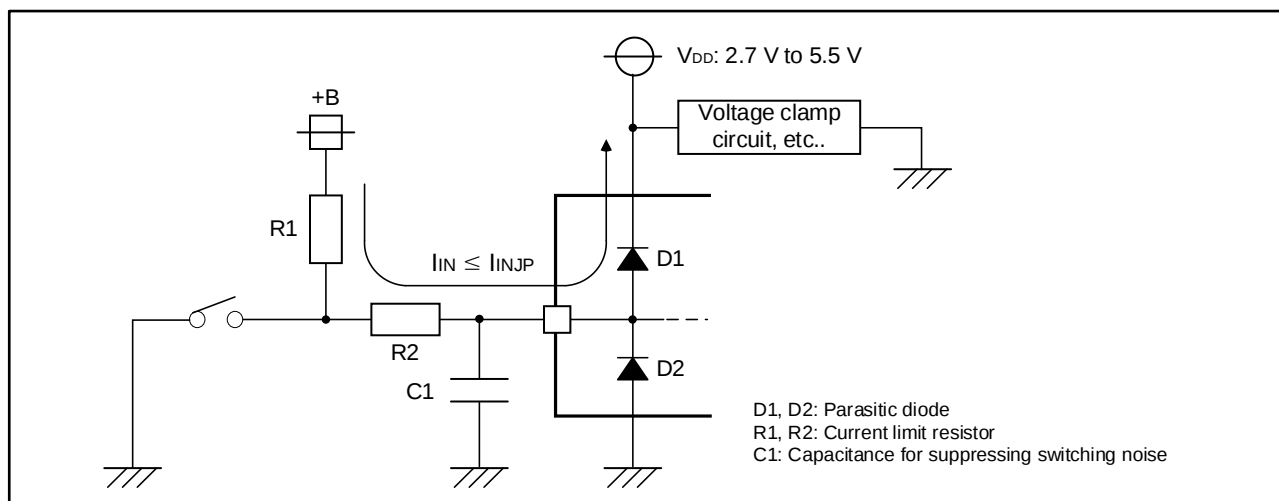


Figure 10: Example of Injected Current Input Circuit

Table 7: Injected Current Input Specifications

| Item                                                  | Port Type | Conditions                                                            | Injected Current Specifications (MAX.)                                                           |
|-------------------------------------------------------|-----------|-----------------------------------------------------------------------|--------------------------------------------------------------------------------------------------|
| Positive injected current<br>( $V_{IN} \geq V_{DD}$ ) | EVDD-type | P40, P130 (Output-only pin)                                           | Prohibition                                                                                      |
|                                                       |           | All EVDD-type pins except P40, P70 to P74, P120, P125, and P130       | 0.4 mA (per pin),<br>4.0 mA (Total of EVDD-type pins)                                            |
|                                                       |           | P70 to P74, P120, P125                                                | 0.15 mA (per pin),<br>1.0 mA (total of pins (including VDD-type pins))                           |
|                                                       | VDD-type  | All VDD-type pins except P33, P34, P81 to P84, P121 to P124, and P137 | 0.15 mA (per pin),<br>1.0 mA (total of pins (including EVDD-type pins (P70 to P74, P120, P125))) |
|                                                       |           | P33, P34, P121 to P124, P137                                          | Prohibition                                                                                      |
|                                                       |           | P81 to P84                                                            | 0.15 mA (per pin),<br>0.15 mA (total of pins)                                                    |

Note The above specifications are not tested in the outgoing inspection, but they are specified based on the design rules and the device characterization.

## 1.6 Note for A/D Converter

### 1.6.1 Voltage Range of Analog Power Supply Pins

Observe the following conditions:

- Analog input voltage range  
Voltage applied to analog input pins ANIn:  $AV_{REFM} \leq V_{AIN} \leq AV_{REFP}$   
Reference voltage range applied to the  $AV_{REFP}$  pin:  $AV_{REFP} \leq V_{DD}$   
Voltage applied to analog input pins ANIn ( $n = 0$  to  $30$ ):  $V_{SS} \leq V_{AIN} \leq V_{DD}$
- Relationship between power supply pin pairs ( $AV_{REFP} - AV_{REFM}$ ,  $V_{DD} - V_{SS}$ )  
Connect a capacitor with a low equivalent resistance and a good frequency response to the power supply.  
When performing A/D conversion of analog input pin ANIn ( $n = 0$  to  $30$ ), a capacitor should be connected between each pair of power supply pins to create a closed loop with the shortest route possible as shown in Figure 11, and connection should be made so that the following conditions are satisfied at the supply side.

$$AV_{REFM} = V_{SS}$$

When the 12-bit A/D converter is not used, the following conditions should be satisfied.

$$AV_{REFP} = V_{DD} \text{ and } AV_{REFM} = V_{SS}$$

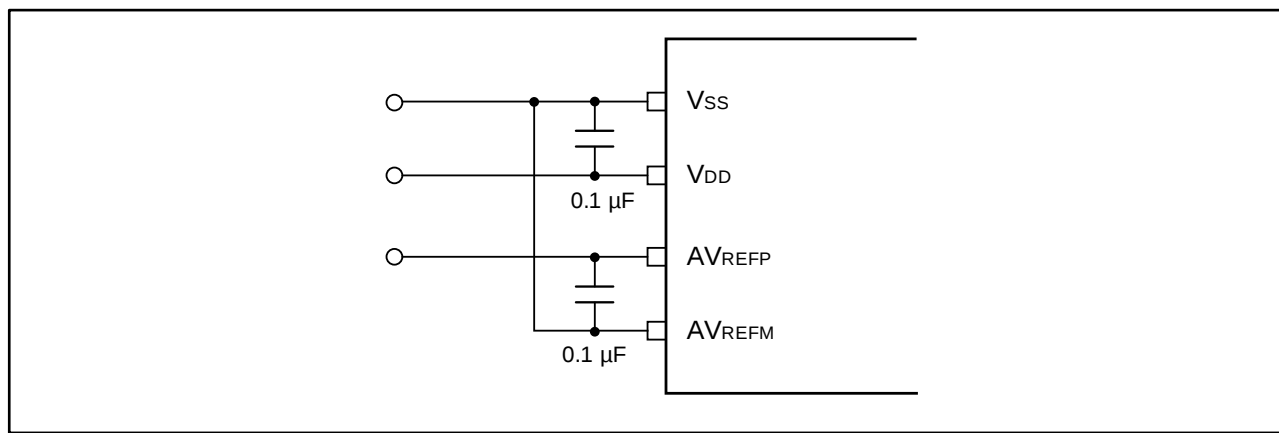


Figure 11: Power Supply Pin Connection Example

### 1.6.2 Notes on Board Design

- Separate the digital power supply pattern ( $V_{DD}$ ,  $EV_{DD0}$ ,  $EV_{DD1}$ ,  $V_{SS}$ ,  $EV_{SS0}$ ,  $EV_{SS1}$ ) and the analog reference power supply pattern ( $AV_{REFP}$ ,  $AV_{REFM}$ ) and layout them with the possible thick wiring patterns.
- Individually prepare the voltage supply sources for the digital power supply ( $V_{DD}$ ,  $EV_{DD0}$ ,  $EV_{DD1}$ ) and the analog reference power supply ( $AV_{REFP}$ ) for the 12-bit A/D converter.
- When using the single voltage supply source, branch off from the vicinity of the output terminal on the voltage supply source and supply it to the digital power supply ( $V_{DD}$ ,  $EV_{DD0}$ ,  $EV_{DD1}$ ,  $V_{SS}$ ,  $EV_{SS0}$ ,  $EV_{SS1}$ ) and the analog reference power supply ( $AV_{REFP}$ ,  $AV_{REFM}$ ) of the 12-bit A/D converter.
- Connect the analog ground ( $AV_{REFM}$ ) pattern to the stable digital ground ( $V_{SS}$ ) pattern on the board at only one point to prevent a noise from the digital ground.

### 1.6.3 Notes on Noise Prevention

- To prevent the analog input pins (ANI0 to ANI30) from being destroyed by abnormal voltage such as excessive surge, a capacitor should be inserted between  $V_{DD}$  and  $V_{SS}$  and between  $AV_{REFP}$  and  $AV_{REFM}$ , and a protection circuit should be connected to protect the analog input pins (ANIx) as shown in Figure 12.
- The A/D conversion result may vary due to fluctuations of the power supply voltage which is caused by changing of a port output current, large current consumption changes by erasing or writing operation of the flash memory, or the effects of noise. Also, if there is noise on the analog input terminal (ANIx), power supply voltage ( $V_{DD}$ ,  $V_{SS}$ ), or reference voltage input terminal ( $AV_{REFP}$ ,  $AV_{REFM}$ ), the conversion result may vary. Apply software processing to avoid negative influence by variations of the results of A/D conversion to the system. Examples of software processing are described below.
  - Use averaged values from several rounds of A/D conversion
  - Execute A/D conversion for several time and rule out extreme results
- The accuracy is improved if the HALT mode is set immediately after the start of conversion.
- When A/D conversion of the signal on any channel (ANIx) is selected, do not change the levels output on P33, P34, P70 to P74, P80 to P87, P90 to P97, P100 to P105, P120, and P125 during conversion, since doing so may decrease the accuracy.
- When a pin adjacent to a pin

When a pin adjacent to a pin on which A/D conversion is in progress is used as a digital I/O port pin, the result of A/D conversion may differ from the accurate value due to noise coupling. Take care to avoid pulses which change dramatically, like digital signals, being input or output through adjacent pins during A/D conversion.

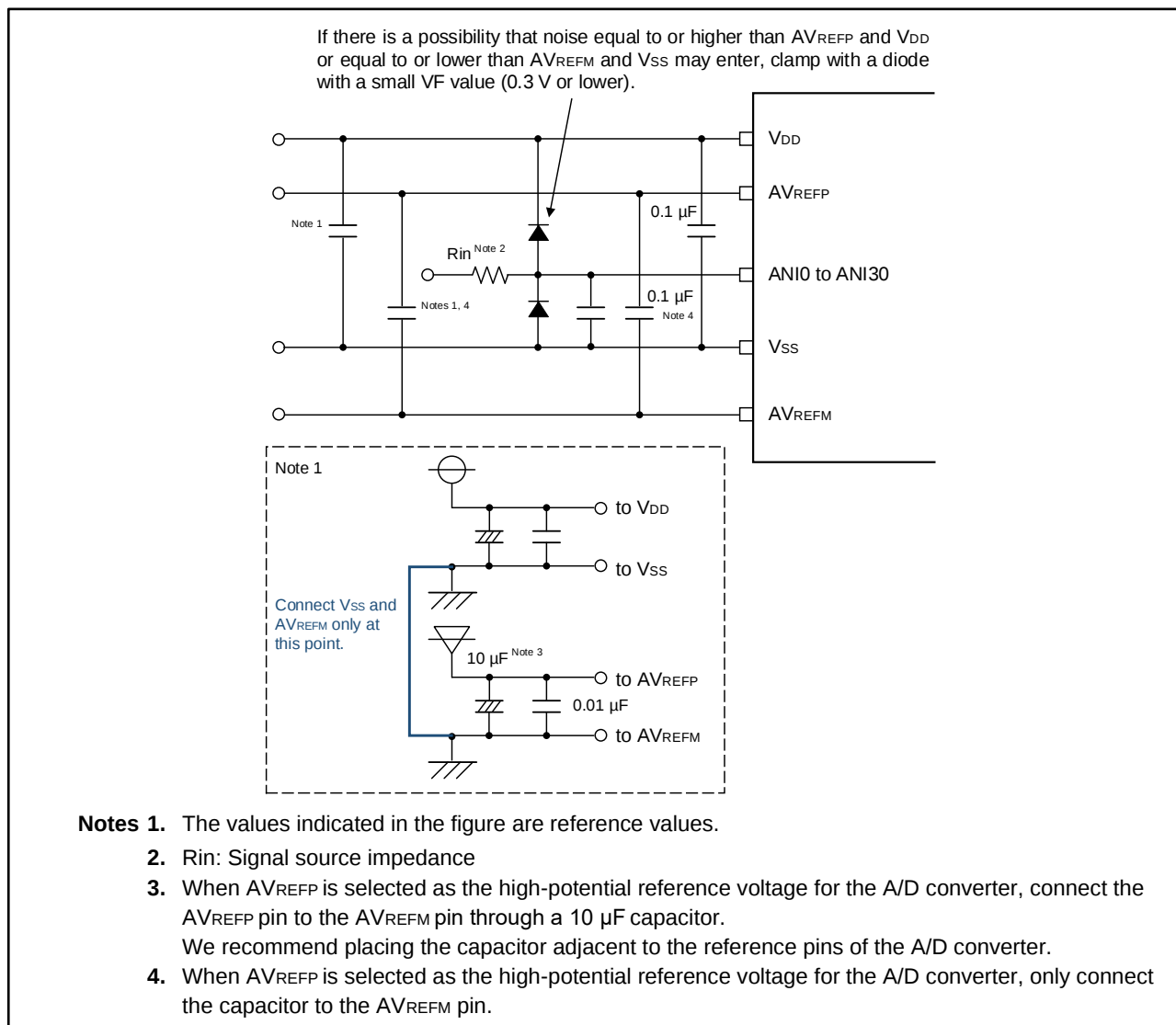


Figure 12: Sample Protection Circuit for Analog Inputs

1.6.4 Internal Equivalent Circuit

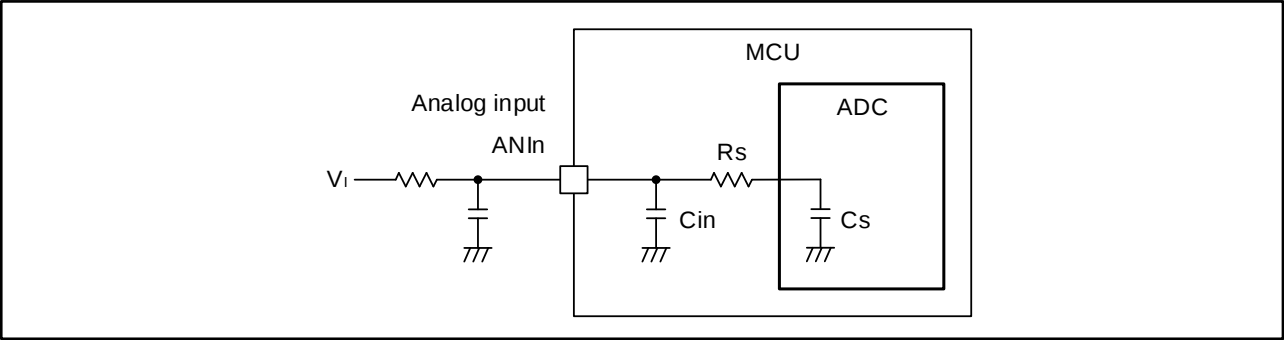


Figure 13: Equivalent Circuit of ANIn Pins

Table 8: Example of the Specifications of the Internal Equivalent Circuit

| ANIn                                               | Cin [pF] | Rs [kΩ] | Cs [pF] |
|----------------------------------------------------|----------|---------|---------|
| ANI0, ANI3 to ANI5, ANI8 to ANI15                  | 8        | 2.5     | 8       |
| ANI1, ANI2 (without channel dedicated S&H circuit) | 8        | 2.5     | 8       |
| ANI1, ANI2 (with channel dedicated S&H circuit)    | 8        | 10.5    | 3       |
| ANI6, ANI7                                         | 10       | 2.5     | 8       |
| ANI16 to ANI30                                     | 8        | 6.7     | 9       |

Note: The values of these parameters are for reference only and are not guaranteed.

## 1.7 On-chip Debug Circuit

RL78/F23, F24 uses the  $V_{DD}$ ,  $EV_{DD0}$ , RESET, TOOL0, and  $V_{SS}$  pins to communicate with the host machine via an E2/E2 LITE on-chip debugging emulator. Serial communication is performed by using a single-line UART that uses the TOOL0 pin. For detail, refer “E1/E20/E2 Emulator, E2 Emulator Lite Additional Document for User’s Manual (Notes on Connection of RL78)” (Document No. R20UT1994EJ).

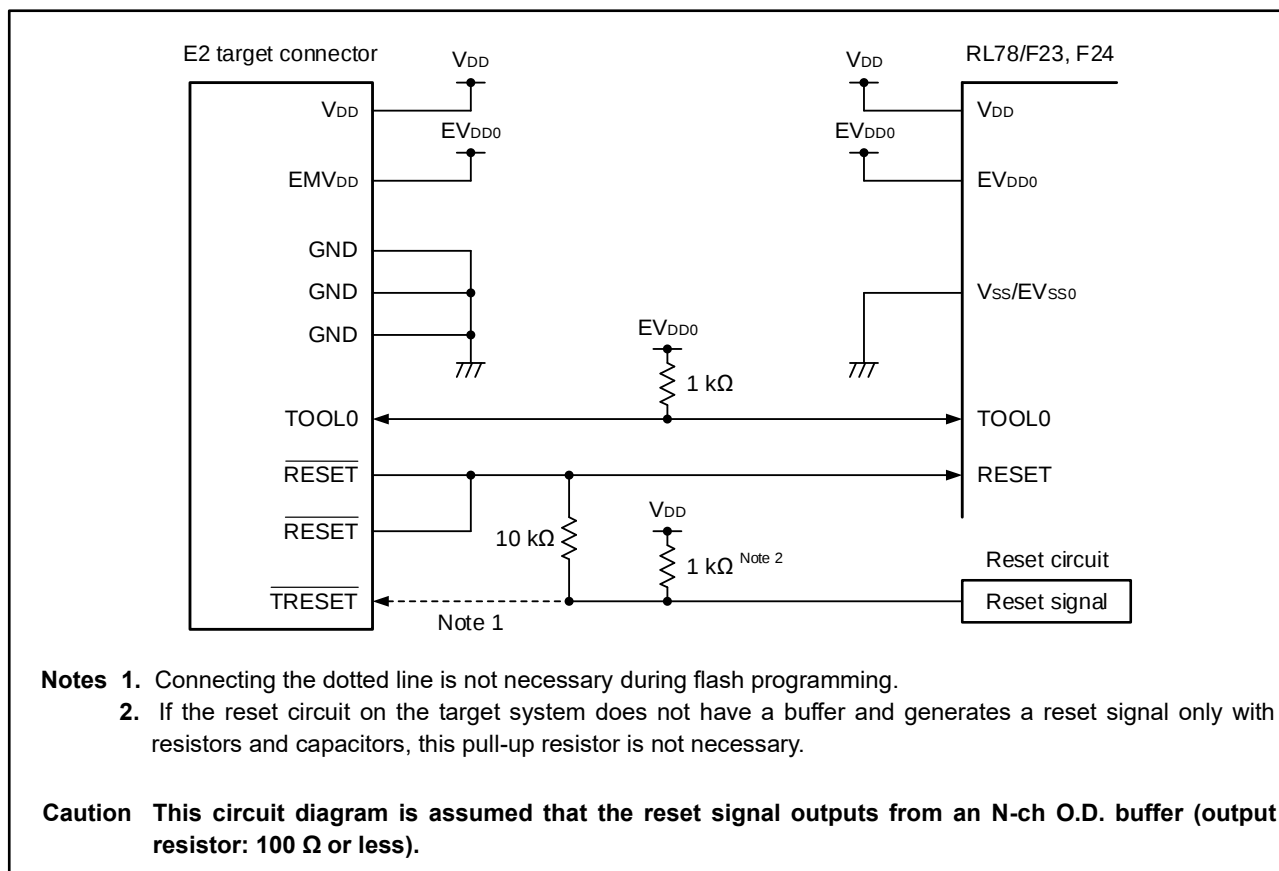


Figure 14: Connection Example of E2 On-chip Debugging Emulator and RL78/F23, F24

**Related Documents**

| Document Name                                                                                               | Document No |
|-------------------------------------------------------------------------------------------------------------|-------------|
| RL78/F23, F24 User's Manual: Hardware                                                                       | R01UH0944E  |
| E1/E20/E2 Emulator, E2 Emulator Lite Additional Document for User's Manual<br>(Notes on Connection of RL78) | R20UT1994E  |

**Revision History**

| Rev. | Date         | Description |                                                                                                                 |
|------|--------------|-------------|-----------------------------------------------------------------------------------------------------------------|
|      |              | Page        | Summary                                                                                                         |
| 1.00 | Nov 30, 2022 | —           | First issue                                                                                                     |
| 2.00 | Sep 30, 2023 | P.2         | Figure 1, Updated typical circuit.                                                                              |
|      |              | P.3         | Table 1, Updated comments in the “Remark”.                                                                      |
|      |              | P.4         | Added new description “1.1.1 Power Supply Pin”. And the pattern example shown in Figure 2 was added.            |
|      |              | P.8         | Added new description “1.4.1 Oscillator Input/Output Pin”. And the pattern example shown in Figure 7 was added. |
|      |              | P.16        | The circuit example in Figure 12 has been modified.                                                             |
|      |              |             |                                                                                                                 |

# General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

## 1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity.

Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

## 2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

## 3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

## 4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

## 5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

## 6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.).

## 7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

## 8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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## Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,  
Koto-ku, Tokyo 135-0061, Japan  
[www.renesas.com](http://www.renesas.com)

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